Modular Jack Connector for High-Speed Transmission

TM24R Series



Features

1. Unique contact configuration (Patented) and board-mounting pattern

The adjacent contacts have different angles of engagement thus increasing the distance between them, in effect reducing the cross talk within connector and its footprint.

Contact #3 and # 6, affecting the cross talk the most; have been isolated from other contacts resulting in maximum NEXT noise suppression.

In addition, the board layout allows easy tracing of the differential signal lines.

2. Full EMI shielding

The entire connector is covered with a metal shell. Multiple panel ground contact springs (2 on each side of the mating opening) and 4 board ground connection solder contacts placed at each corner of the connector guarantee effective suppression of noise radiation.

3. Sequential mating

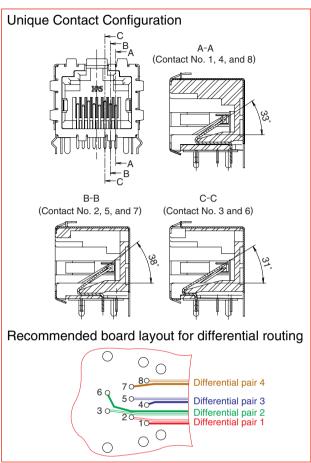
Separate ground springs (Patent pending) make contact with the mating connector's ground before the signal contacts, allowing equalization of any ground differential.

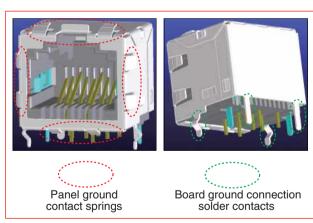
4. Conforms to FCC (Federal Communications Commission) standards

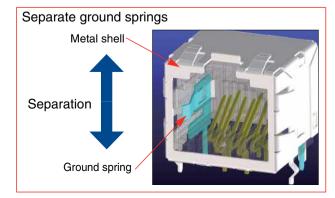
Meets requirements of FCC Title 47, Part 68, Subpart F.

Applications

LAN related equipment, measuring instruments, office equipment and other high transmission speed applications requiring use of high performance modular jacks.







■Product Specifications

Ratings	Current rating 1A Voltage rating 125V AC	Operating temperature range: -25℃ to +80℃ (Note)
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Item	Specification	Conditions	
1. Insulation resistance	100M ohms min.	100V DC	
2. Withstanding voltage	No flashover or insulation breakdown.	500V AC / one minute	
(Basic terminal between 123-456-78)	No hashover of insulation breakdown.		
3. Withstanding voltage	No flashover or insulation breakdown.	1500V AC / one minute	
(Terminal to shield)	No hashover of insulation breakdown.		
4. Contact resistance	50m ohms max.	100mA	
5. Vibration	No electrical discontinuity of 5μ s or more.	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 3 axis,	
5. VIDIALIOII	No damage, cracks, or parts dislocation.	10 cycles	
6. Shock	No electrical discontinuity of 5μ s or more.	Acceleration of 490 m/s2, 11 ms duration, sine half-wave	
o. Shock	Contact resistance: 60 m ohms max.	waveform, 3 cycles / each of 6 axis	
7. Durability (insertion/withdrawal)	Contact resistance: 60 m ohms max.	700 cycles	
	Insulation resistance: 100 M ohms min.	(Temperature: -55 °C $\rightarrow +15$ °C to $+35$ °C $\rightarrow +85$ $\rightarrow +15$ °°C to $+35$ °C	
8. Temperature cycle	Contact resistance: 60 m ohms max.	Duration: $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to 3 (Minutes)	
	Contact resistance, of in onins max.	5 cycles	
O. Humidita	Insulation resistance: 1 M ohms min. (High hujmidity)	500 hours at 40°C, HR 90% to 95%	
9. Humidity	Insulation resistance: 10 M ohms min. (Dry state)		
10. Salt spray	Contact resistance: 60 m ohms max.	5% water solution for 48 hours	

Note: Includes temperature rise caused by current flow.

Temperature range for mechanical operation : -25°C to +60°C

■Materials

Part	Material	Finish	Remarks
Insulator	PBT	Color: Black	UL94V-0
		Contact area: Gold plated 1.27 μm	
Contact	Phosphor bronze	Termination area: Gold plated 0.03 μ m	
		Under plate: Nickel plated 1μm	
Shield	Brass	Tin reflow plated 1 μ m	
Ground spring	Phosphor bronze	Tin reflow plated 1 μ m	

■Ordering information

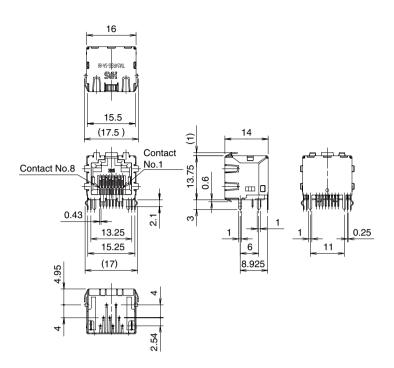


0	Series name	: TM24
2	Connector type	: R Jack
3	Shell type	: SG Separate ground spring –outer shell
4	Jack type	: 5A Right-angle dip
6	Jack opening code	: 8 8 contacts
6	Number of inserted contact	: 8 8 contacts

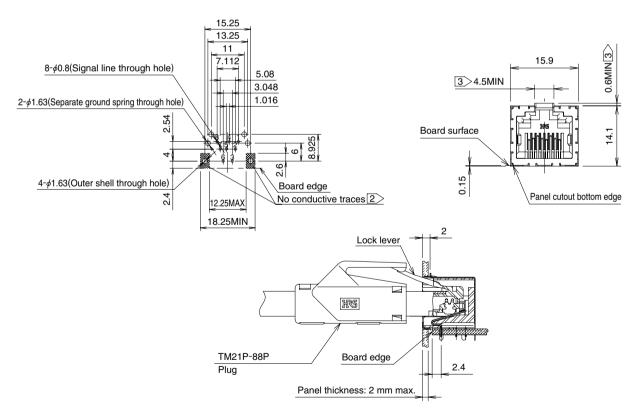
■ Modular Jack Connectors



Part number	CL No.	RoHS
TM24RSG-5A-88	222-2946-7-00	YES



◆Recommended PCB mounting pattern

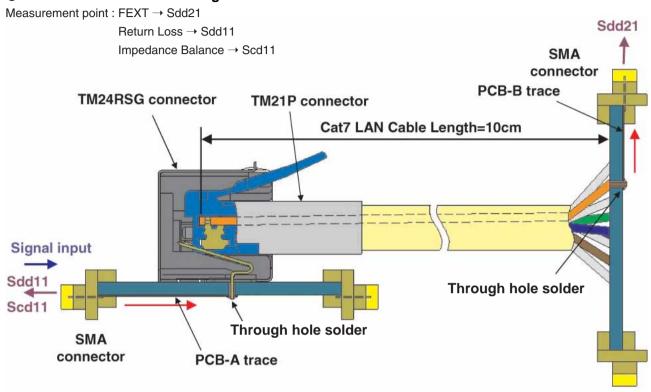


- * Precautions and recommendations for board and panel design
- 1 . Recommended board thickness: 1.6 mm.
- 2. No conductive traces in the crosshatched areas.
- 3). Make sure that the panel cutout has enough clearance to assure free operation of the lock lever of the mating plug.
- 4. Make sure that the panel cutout bottom edge is 0.15 mm below the board-mounting surface.
- 5. Connector can be cleaned with isopropyl alcohol (IPA) at room temperature.

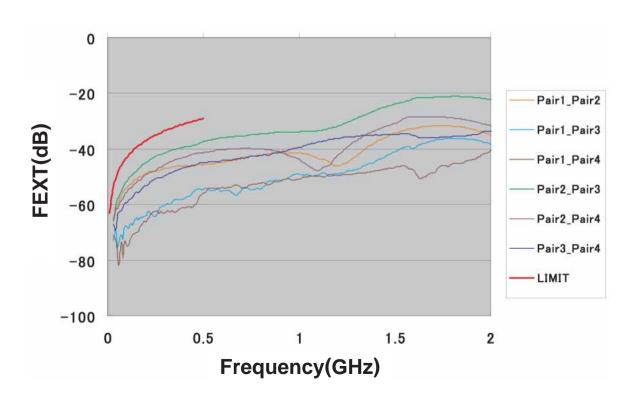
■Signal Integrity Data

These are the representative values of the electrical performance demanded for modular connectors according to IEEE802.3-an (10GBASE-T).

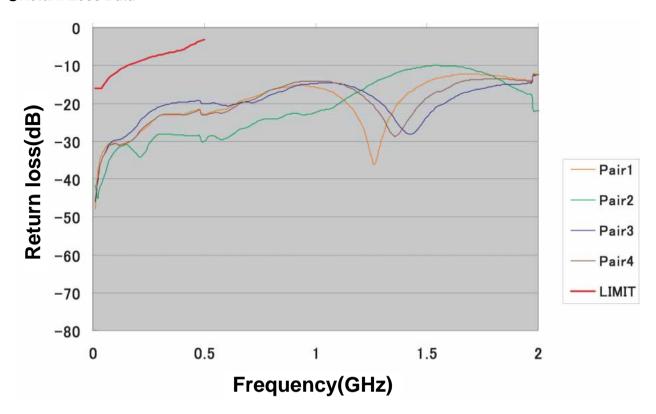
●Measurement Outline Drawing



●FEXT Data



●Return Loss Data



●Impedance Balance Data

